

# HL6362MG/63MG

## Low Operating Current Visible Laser Diode

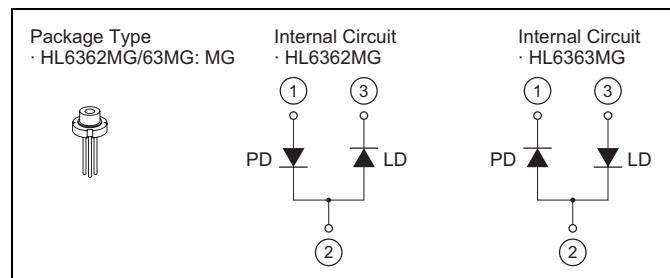
ODE-208-011E (Z)  
Rev.5  
Apr. 14, 2006

### Description

The HL6362MG/63MG are 0.63  $\mu\text{m}$  band AlGaInP laser diodes with a multi-quantum well (MQW) structure. They are suitable as light sources for laser display, laser scanners and optical equipment for measurement.

### Features

- Visible light output : 640 nm Typ
- Single longitudinal mode
- Optical output power : 40 mW CW
- Low operating current : 90 mA Typ
- Low operating voltage : 2.6 V Max
- Operating temperature : +50°C
- TE mode oscillation



### Absolute Maximum Ratings

( $T_C = 25^\circ\text{C}$ )

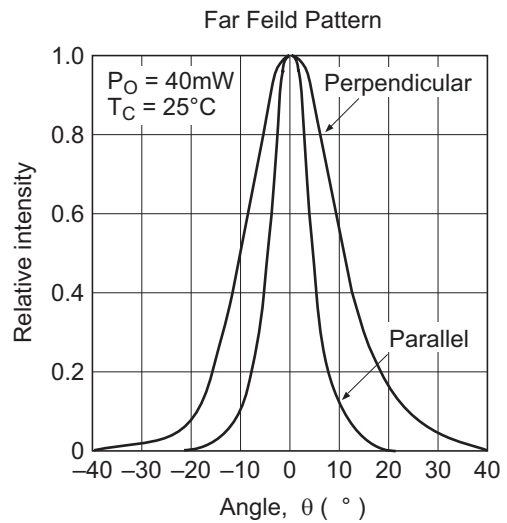
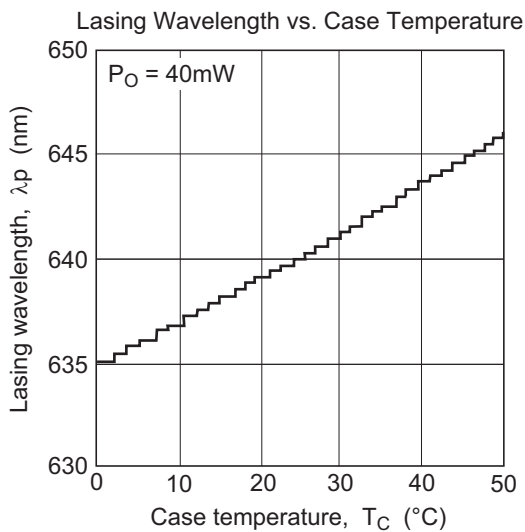
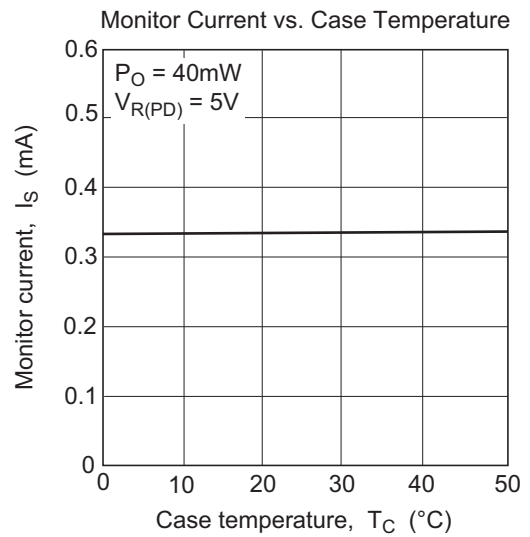
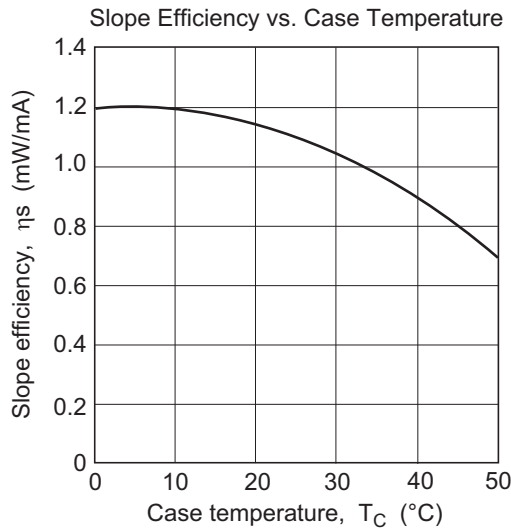
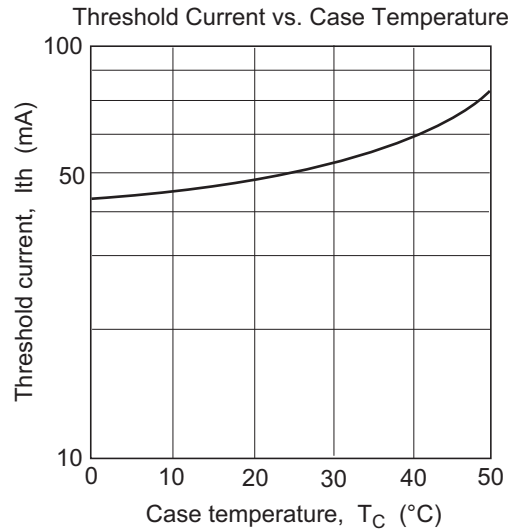
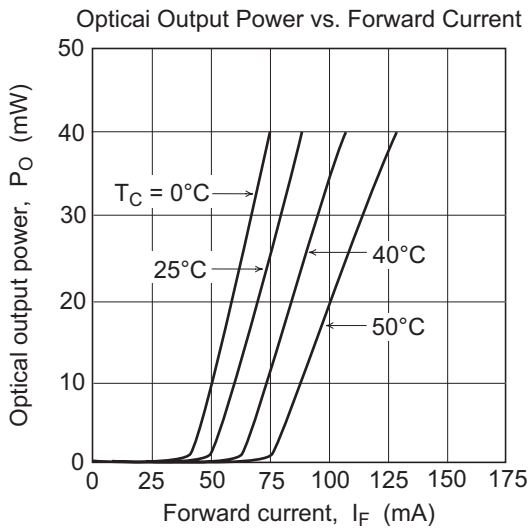
Item	Symbol	Ratings	Unit
Optical output power	$P_O$	45	mW
LD reverse voltage	$V_{R(LD)}$	2	V
PD reverse voltage	$V_{R(PD)}$	30	V
Operating temperature	$T_{opr}$	-10 to +50	$^\circ\text{C}$
Storage temperature	$T_{stg}$	-40 to +85	$^\circ\text{C}$

### Electrical Characteristics

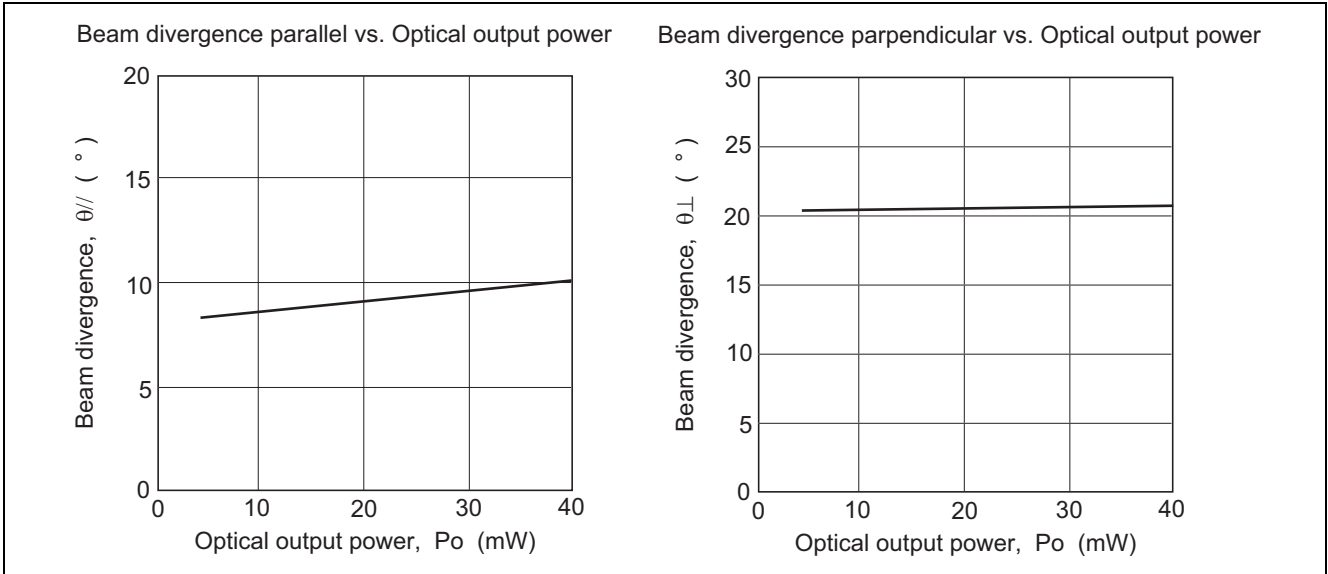
( $T_C = 25^\circ\text{C}$ )

Item	Symbol	Min	Typ	Max	Unit	Test Condition
Threshold current	$I_{th}$	—	45	60	mA	—
Operating current	$I_{op}$	—	90	110	mA	$P_O = 40 \text{ mW}$
Operating voltage	$V_{OP}$	—	2.4	2.6	V	$P_O = 40 \text{ mW}$
Beam divergence parallel to the junction	$\theta_{//}$	7	10	13	$^\circ$	$P_O = 40 \text{ mW}$
Beam divergence perpendicular to the junction	$\theta_{\perp}$	16	21	24	$^\circ$	$P_O = 40 \text{ mW}$
Lasing wavelength	$\lambda_p$	—	640	643	nm	$P_O = 40 \text{ mW}$
Monitor current	$I_s$	0.15	0.30	0.60	mA	$P_O = 40 \text{ mW}, V_{R(PD)} = 5 \text{ V}$

Typical Characteristic Curves

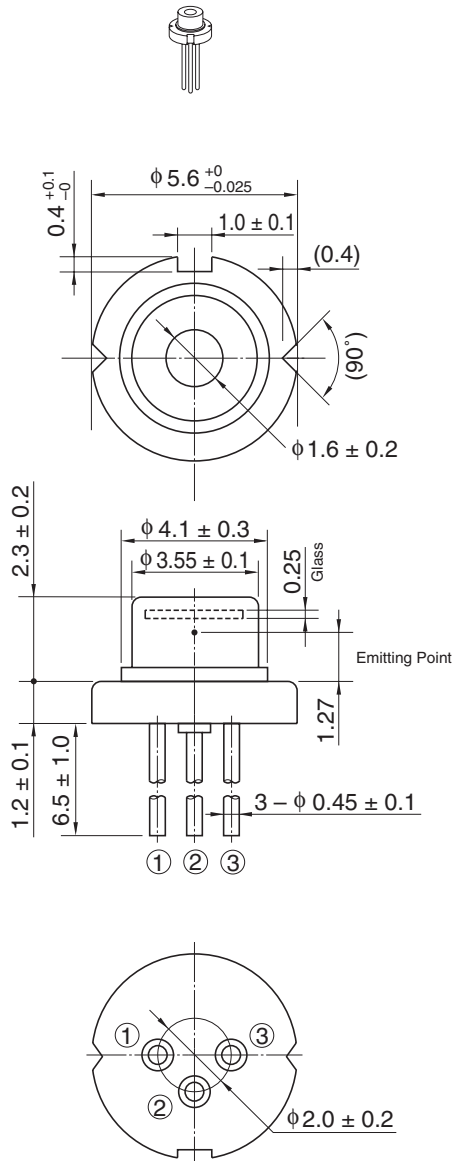


### Typical Characteristic Curves (cont.)



Package Dimensions

As of July, 2002  
Unit: mm



OPJ Code	LD/MG
JEDEC	—
JEITA	—
Mass (reference value)	0.3 g

## Cautions

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1. The laser light is harmful to human body especially to eye no matter what directly or indirectly. The laser beam shall be observed or adjusted through infrared camera or equivalent.
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When disposing of the product, please follow the laws of your country and separate it from other waste such as industrial waste and household garbage.
3. Definition of items shown in this CAS is in accordance with that shown in Opto Device Databook issued by OPJ unless otherwise specified.

## Sales Offices



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For the detail of Opnext, Inc., see the following homepage:

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